

**Layer Stacking**

TOP  
BOTTOM

Overall Board Thickness: 62 Mil

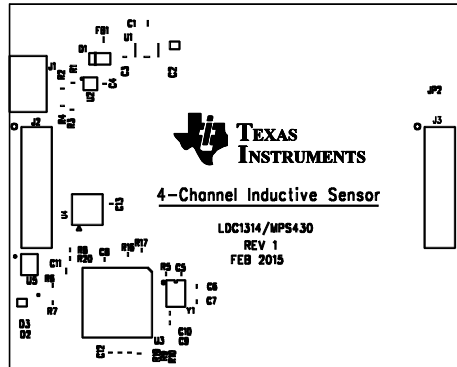
Soldermask Color: RED

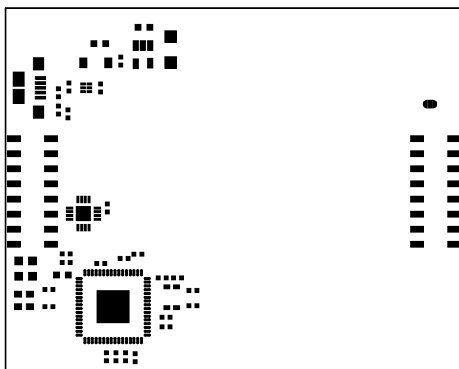
Silkscreen Color: White

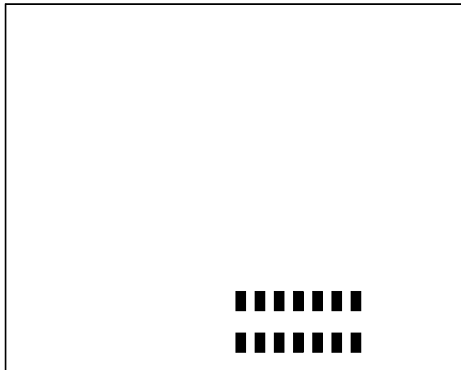
Drill hole tolerance: +/-3 Mil

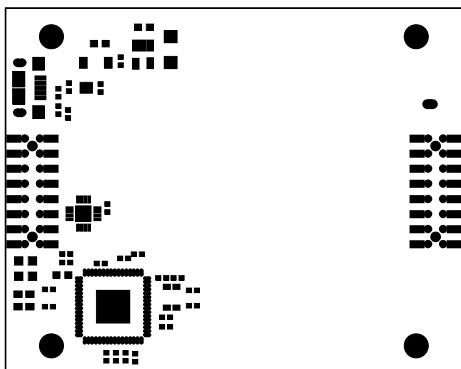
1		TOP COMPONENT		
COMPANY	TI-SVA			
PCB PART NUMBER	MCU	REV	1	
DATE	2/14/15			
NOTES				

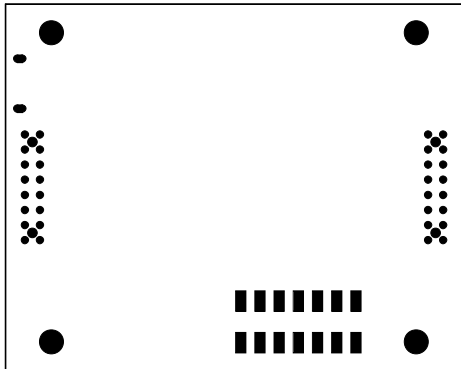
SIZE	QTY	SYM	PLATED	TOL
122	4	⊗	NO	+/-0.0
13	93	□	YES	+/-0.0
47.24	4	◇	NO	+/-0.0
35.04	32	⊗	NO	+/-0.0
25	5	⊗	YES	+/-0.0
19.69 x 47.24	2	⊕ <sup>A</sup>	YES	+/-0.0



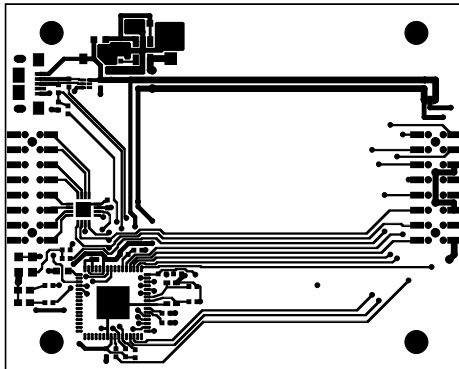




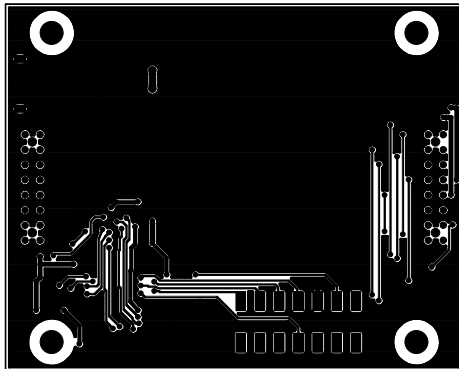








1 TOP COMPONENT



2 BOTTOM COMPONENT

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